

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
XINRU WANG	06/03/2015
XIN JIN	06/03/2015
YONG HE	06/03/2015
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<b>Internal Address:</b>	Bantian, Longgang District
<b>City:</b>	Shenzhen, Guangdong
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<b>Postal Code:</b>	518129
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14732373
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<b>ATTORNEY DOCKET NUMBER:</b>	HW720847
<b>NAME OF SUBMITTER:</b>	JOHN B. CONKLIN
<b>SIGNATURE:</b>	/John B. Conklin/
<b>DATE SIGNED:</b>	06/05/2015
<b>Total Attachments: 2</b>	
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**PATENT**

Attorney Docket No. HW720847  
Client Reference No. 83765453US03

**ASSIGNMENT**

**WHEREAS, WE,**

Xinru WANG  
Huawei Administration Building  
Bantian, Longgang District  
Shenzhen, 518129, Guangdong  
P.R. CHINA; and

Xin JIN  
Huawei Administration Building  
Bantian, Longgang District  
Shenzhen, 518129, Guangdong  
P.R. CHINA; and

Yong HE  
Huawei Administration Building  
Bantian, Longgang District  
Shenzhen, 518129, Guangdong  
P.R. CHINA;

have invented and own a certain invention entitled:

**ADAPTIVE VOLTAGE SCALING CIRCUIT AND CHIP**

for which invention we have executed an application (provisional or non-provisional) for a U.S. patent, which was filed on 06/05/2015, under U.S. Application No. \_\_\_\_\_ and

14/732,373

**WHEREAS, HUAWEI TECHNOLOGIES CO., LTD.**, of Huawei Administration Building, Bantian, Longgang District, Shenzhen, 518129, Guangdong, P.R. China, hereinafter referred to as Assignee, is desirous of acquiring the entire domestic and foreign right, title, and interest in and under the invention described in the patent application.

**NOW, THEREFORE**, for good and valuable considerations, the receipt and sufficiency of which are hereby acknowledged, we assign and transfer to the Assignee and the Assignee's legal representatives, successors and assigns the full and exclusive rights in and to the invention in the U.S. and every foreign country and the entire right, title, and interest in and to the patent application and other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisionals, reissues, reexaminations, National phase applications, including petty patent applications, and utility model applications) that may be filed in the United States and every foreign country on the invention, and the patents, extensions, or derivations thereof, both foreign and domestic, that may issue thereon, and we do hereby authorize and request the Commissioner of Patents to issue U.S. patents to the above-mentioned Assignee agreeably with the terms of this assignment document.

**WE HEREBY AUTHORIZE** the Assignee to insert in this assignment document the filing date and application number of the application if the date and number are unavailable at the time this document is executed.

**WE DO HEREBY COVENANT** and agree with the Assignee that we will not execute any writing or do any act whatsoever conflicting with the terms of this assignment document set

In re Appln. of Wang et al.  
Attorney Docket No. HW720847

forth herein, and that we will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to perfect the Assignee's enjoyment of this assignment, and render all necessary assistance in making application for and obtaining original, continuation, continuation-in-part, divisional, reissued, reexamined, and National phase patents of the U.S. or of any and all foreign countries on the invention, and in enforcing any rights or chooses in action accruing as a result of such applications or patents, and by executing statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of all parties hereto.

IN WITNESS WHEREOF, We have hereunder set our hands on the dates shown below.

Date June 03, 2015

Xinru WANG  
Xinru WANG

Date June 03, 2015

Xin JIN  
Xin JIN

Date June 03, 2015

Yong HE  
Yong HE